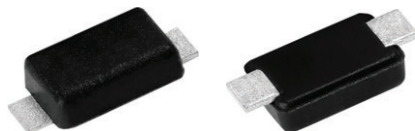


Surface-Mount Fast Avalanche Rectifiers

eSMP® Series



Top view

Bottom view

SMF (DO-219AB)

Cathode  Anode

LINKS TO ADDITIONAL RESOURCES



3D Models


RoHS
COMPLIANT
HALOGEN
FREE

FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated pellet chip junction
- Fast switching for high frequency
- Low reverse current
- Meets MSL level 1, per J-STD-020; LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified
- Automotive ordering code: base P/NHM3
- Compatible to SOD-123W package case outline
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

MECHANICAL DATA

Case: SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

PRIMARY CHARACTERISTICS

$I_{F(AV)}$	1.0 A
V_{RRM}	200 V, 400 V, 600 V, 800 V, 1000 V
I_{FSM}	30 A, 25 A
t_{rr}	140 ns, 120 ns
I_R	1 μ A
V_F at $I_F = 1$ A	1.15 V, 1.4 V
E_{AS}	20 mJ
T_J max.	175 °C
Package	SMF (DO-219AB)
Circuit configuration	Single

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	AR1FD	AR1FG	AR1FJ	AR1FK	AR1FM	UNIT
Device marking code		ARD	ARG	ARJ	ARK	ARM	
Max. repetitive peak reverse voltage	V _{RRM}	200	400	600	800	1000	V
Max. DC forward current (see fig. 1)	I _F ⁽¹⁾	1.0					A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	30			25		A
Non-repetitive avalanche energy at I _{AS} = 1.0 A, T _A = 25 °C	E _{AS}	20					mJ
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175					°C

Note

(1) Free air, mounted on recommended PCB, 2 oz. pad area

**ELECTRICAL CHARACTERISTICS** ($T_J = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)

PARAMETER	TEST CONDITIONS	SYMBOL	AR1FD	AR1FG	AR1FJ	AR1FK	AR1FM	UNIT
Maximum instantaneous forward voltage	$I_F = 1.0\text{ A}$	$T_J = 25\text{ }^{\circ}\text{C}$	1.25			1.6		V
		$T_J = 125\text{ }^{\circ}\text{C}$						
Maximum reverse current	Rated V_R	$T_J = 25\text{ }^{\circ}\text{C}$	1.0			1.4		μA
		$T_J = 125\text{ }^{\circ}\text{C}$						
Maximum reverse recovery time	$I_F = 0.5\text{ A}$, $I_R = 1.0\text{ A}$, $I_{rr} = 0.25\text{ A}$	t_{rr}	140			120		ns
Typical junction capacitance	4.0 V, 1 MHz	C_J	12.6			9.3		pF

Notes(1) Pulse test: 300 μs pulse width, 1 % duty cycle(2) Pulse test: Pulse width $\leq 40\text{ ms}$ **THERMAL CHARACTERISTICS** ($T_A = 25\text{ }^{\circ}\text{C}$ unless otherwise noted)

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	AR1FD	AR1FG	AR1FJ	AR1FK	AR1FM	UNIT
Typical thermal resistance	R _{θJA} ⁽¹⁾⁽²⁾	130					°C/W
	R _{θJM} ⁽¹⁾	20					

Notes(1) Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta JA}$ - junction to ambient; $R_{\theta JM}$ - junction to mount(2) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$ **ORDERING INFORMATION** (Example)

PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
AR1FJ-M3/H	0.0145	H	3000	7" diameter plastic tape and reel
AR1FJ-M3/I	0.0145	I	10 000	13" diameter plastic tape and reel
AR1FJHM3/H ⁽¹⁾	0.0145	H	3000	7" diameter plastic tape and reel
AR1FJHM3/I ⁽¹⁾	0.0145	I	10 000	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified



RATINGS AND CHARACTERISTICS CURVES ($T_A = 25^\circ\text{C}$ unless otherwise noted)

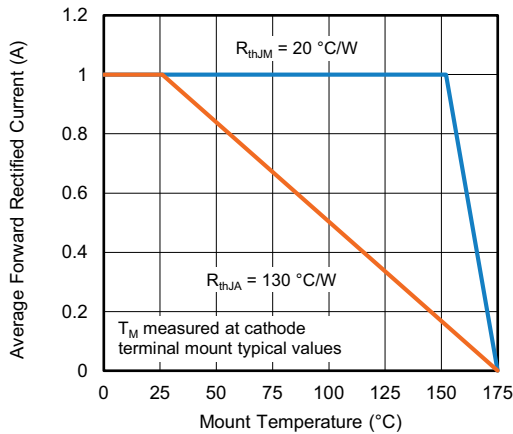


Fig. 1 - Max. Forward Current Derating Curve

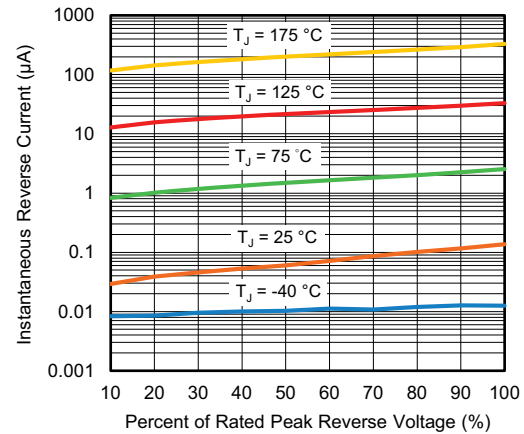


Fig. 4 - Typical Reverse Characteristics

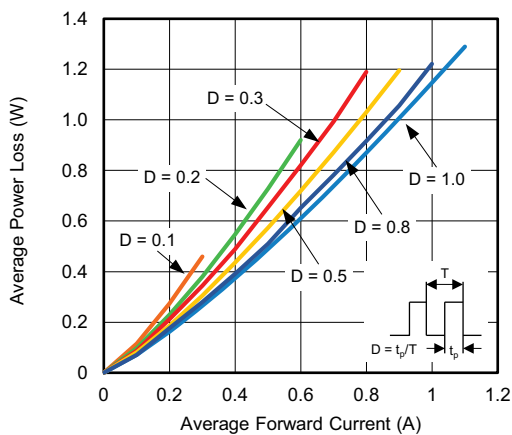


Fig. 2 - Forward Power Loss Characteristics

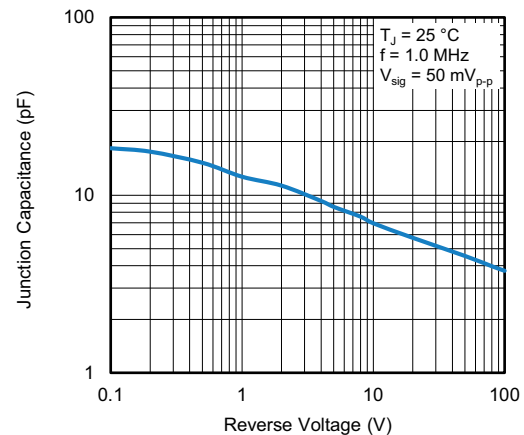


Fig. 5 - Typical Junction Capacitance

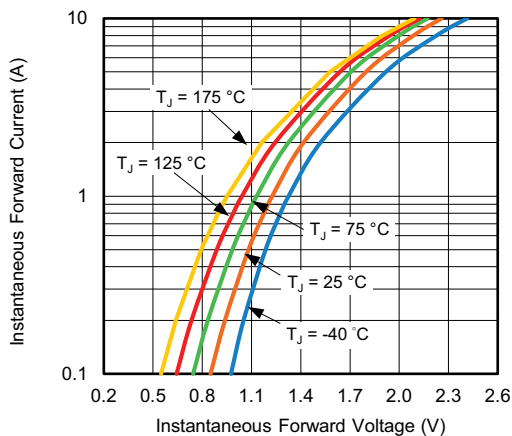


Fig. 3 - Typical Instantaneous Forward Characteristics

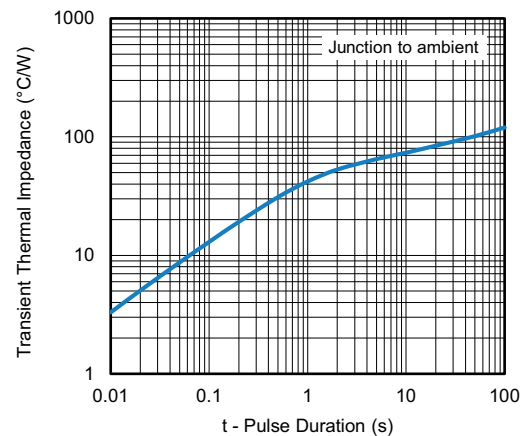
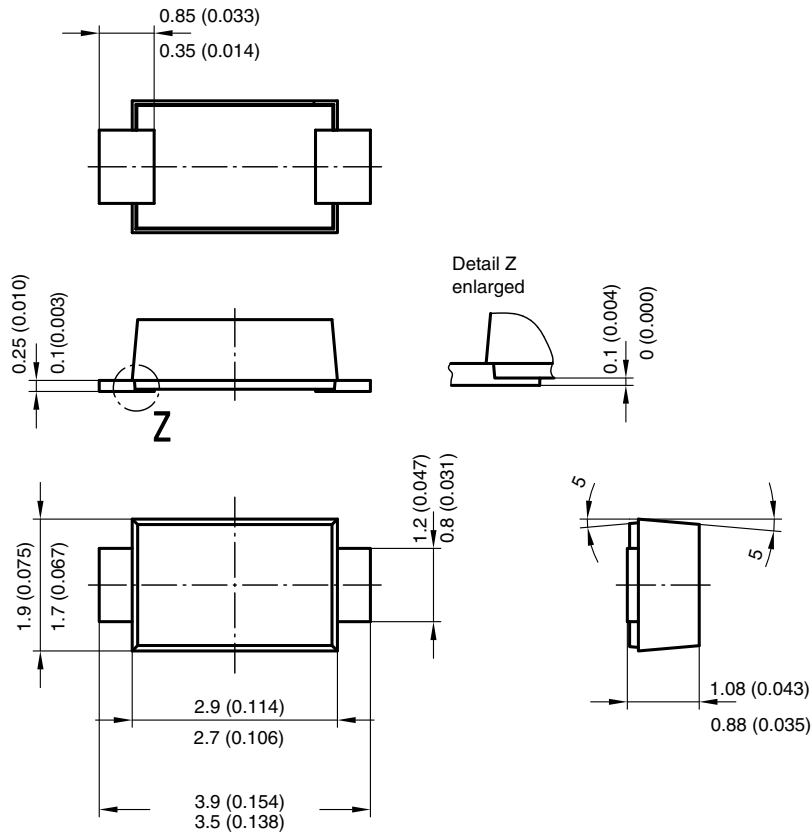


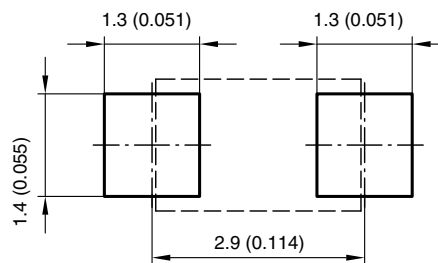
Fig. 6 - Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



Foot print recommendation:



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Rev. 3 - Date: 13. March 2007
Document no.: S8-V-3915.01-001 (4)
17247



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